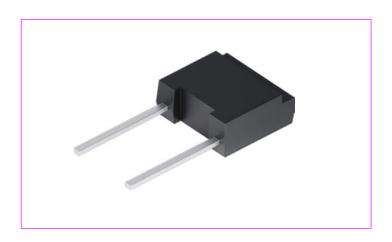
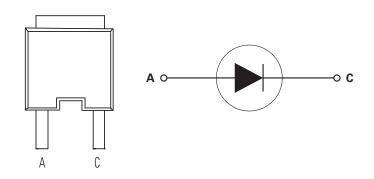
IEC60747



Pinout Diagram



A: Anode; C: Cathode

Preliminary Data

Туре	V _{RSM} (V)	V(_{BR)min} (V)	V _{RRM} (V)
DSA1-12D	1300	1300	1200
DSA1-16D	1700	1750	1600
DSA1-18D	1900	1950	1800

Features:

- Plastic standard package
- Planar passivated chips

Advantages:

- Space and weight savings
- Simple PCB mounting
- Reduced protection circuits
- Improved temperature and power cycling

Applications:

- Low power rectifiers
- Field supply for DC motors
- Power supplies
- High voltage rectifiers

Product Summary

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Characteristic	Value	Unit
V_{RRM}	1200–1800	V
I _{F(RMS)}	7	А
I _{FAVM}	2.3	А

Maximum Ratings

Symbol	Characteristics	Conditions		Units	
I _{F(RMS)}	RMS Forward Current	$T_{VJ} = T_{VJM}$	7	А	
I _{F(AV)M}	Mayirayna Ayaraga Faryyard Cyrrant	$T_{amb} = 45$ °C; $R_{thJA} = 38$ K/W; 180 ° sine	2.3	А	
	Maximum Average Forward Current	$T_{amb} = 45$ °C; $R_{thJA} = 80$ K/W; 180 ° sine	1.3	А	
P _{RSM}	Maximum Surge Reverse Power Dissipation	T_{VJM} ; $t_p = 10 \text{ ms}$	1.6	kW	
I _{FSM}		$T_{VJ} = 45$ °C; t = 10 ms (50 Hz), sine	110		
	Maximum Surge Forward Current	$T_{VJ} = 45$ °C; t = 8.3 ms (60 Hz), sine	118	А	
		T _{VJ} = 150°C; t = 10 ms (50 Hz), sine		^	
		$T_{VJ} = 150$ °C; t = 8.3 ms (60 Hz), sine	104	А	
		$T_{VJ} = 45$ °C; t = 10 ms (50 Hz), sine	60	A ² s	
l²t	I ² t Value for Fusing	T _{VJ} = 45°C; t = 8.3 ms (60 Hz), sine	58	A-S	
		$T_{VJ} = 150^{\circ}C$; t = 10 ms (50 Hz), sine	50	A ² s	
		T _{VJ} = 150°C; t = 8.3 ms (60 Hz), sine	45		
T _{VJ}	Virtual Junction Temperature	40 to -		°C	
T _{VJM}	Maximum Virtual Junction Temperature	-	150	°C	
T _{stg}	Storage Temperature	-	-40 to +150	°C	

Static Characteristics

Cumhal	Characteristics	Conditions				Units
Symbol	Characteristics			Тур.	Max.	Units
I _R	Reverse Current	$T_{VJ} = T_{VJM}$	$V_R = V_{RRM}$	-	0.7	mA
V _F	Forward Voltage	I _F = 7 A	T _{VJ} = 25°C	_	1.34	V
V _{TO}	Threshold Voltage	For power-loss calculation only		-	0.8	V
r _T	Slope Resistance	$T_{VJ} = T_{VJM}$		_	67	mΩ

Thermal Specifications

Cumbal	Characteristics	Conditions		Value	
Symbol	Guaracteristics			Max.	Unit
R _{thJA} Maximum Thermal Resistance, Junctio to Ambient	Forced Air Cooling with 1.5 m/s; T _{amb} = 45°C	-	38	K/W	
	to Ambient	Soldered on to PC board; T _{amb} = 45°C	_	80	K/W

Physical Specifications

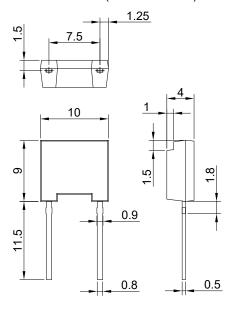
Symbol	Characteristics	Conditions	Value		Unit
	Characteristics	Conditions		Max.	
wt	Weight	-	0.8	-	g
d _S	Creep distance on surface	-	_	8.5	mm
d _A	Strike distance through air	-	_	6.7	mm
а	Acceleration	-	-	100	m/s²



DSA1 Diode **Datasheet**

Part Outline Drawing

Dimension in mm (1 mm = 0.0394")



Disclaimer Notice

Information furnished is believed to be accurate and reliable. However, users should independently evaluate the suitability of and test each product selected for their own applications. Littelfuse products are not designed for, and may not be used in, all applications.









